

T1635H Series

Snubberless™ high temperature 16 A Triacs

Main features

Symbol	Value	Unit
I _{T(RMS)}	16	Α
V_{DRM}/V_{RRM}	600	V
I _{GT (Q1)}	35	mA

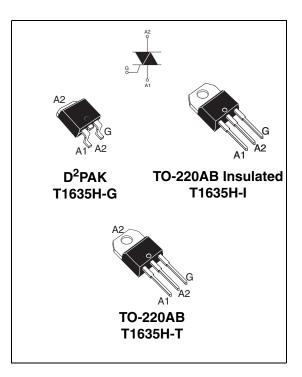
Description

Specifically designed to operate at 150° C, the new 16 A T1635H Triacs provide an enhanced performance in terms of power loss and thermal dissipation. This facilitates the optimization of heatsink dimensioning, leading to improved space and cost effectiveness when compared to electromechanical solutions.

Based on ST Snubberless $^{\text{TM}}$ technology, the T1635H series offers high commutation switching capabilities and high noise immunity levels on the full range of T_i .

The T1635H series facilitates the optimization of the control of universal motors and inductive loads found in appliances such as vacuum cleaners, and washing machines.

The T1635H Triacs are also suitable for use in high temperature environment found in hot appliances such as cookers, ovens, hobs, electric heaters, and coffee machines.



Order code

Part number	Marking
T1635H-600G	T1635H-600G
T1635H-600G-TR	T1635H-600G
T1635H-600TRG	T1635H-600T
T1635H-600IRG	T1635H-600I

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August 2006 Rev 1 1/10

Characteristics T1635H Series

1 Characteristics

Table 1. Absolute maximum ratings

Symbol	Parameter			Value	Unit
I _{T(RMS)}	RMS on-state current (full sine wave)	D ² PAK TO-220AB	T _c = 130° C	16	А
		TO-220AB Ins	T _C = 110° C		
l	Non repetitive surge peak on-state current	F = 60 Hz	t = 16.7 ms	170	Α
TSM	(full cycle sine wave, T _j initial = 25° C)		t = 20 ms	160	^
l²t	$I^{2}t$ Value for fusing $tp = 10$		0 ms	128	A ² s
dl/dt	Critical rate of rise of on-state current $I_G = 2xI_{GT}$, tr \leq 100 ns		T _j = 150° C	50	A/μs
V _{DSM} /V _{RSM}	Non repetitive surge peak off state voltage		T _j = 25° C	700	V
I _{GM}	Peak gate current $t_p = 20 \mu s$		T _j = 150° C	4	Α
$P_{G(AV)}$	Average gate power dissipation $T_j = 150^{\circ} \text{ C}$			1	W
T _{stg} T _j	Storage junction temperature range Operating junction temperature range			-40 to +150 -40 to +150	° C

Table 2. Electrical characteristics ($T_i = 25^{\circ}$ C, unless otherwise specified)

Symbol	Test conditions	Quadrant		Value	Unit
I _{GT} ⁽¹⁾	$V_D = 12 \text{ V, R}_1 = 33 \Omega$	II - III	MAX	35	mA
V _{GT}	VD = 12 V, NL = 33 32	II - III	MAX	1.3	٧
V_{GD}	$V_D = V_{DRM}, R_L = 3.3 \text{ k}\Omega$	11 - 111	MIN	0.15	V
I _H ⁽²⁾	I _T = 100 mA		MAX	35	mA
	I _G = 1.2 x I _{GT}	1 - 111	MAX	50	mA
I _L	I'G - 1.2 A IGT	II	IVIAA	80	
dV/dt (2)	$V_D = 67\% V_{DRM}$, gate open, $T_j = 150^{\circ} C$		MIN	300	V/µs
(dl/dt)c (2)	Without snubber, $T_j = 150^{\circ} C$		MIN	7.1	A/ms

^{1.} minimum $I_{\mbox{\scriptsize GT}}$ is guaranteed at 5% of $I_{\mbox{\scriptsize GT}}$ max

^{2.} for both polarities of A2 referenced to A1

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Table 3. Static electrical characteristics

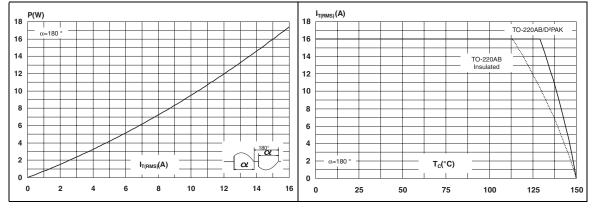
Symbol	Test conditions		Value	Unit	
V _{TM} ⁽¹⁾	I _{TM} = 22.5 A, t _p = 380 μs	Tj = 25° C	MAX	1.5	V
V _{TO} (1)		Tj = 150° C	MAX	0.80	V
R _D ⁽¹⁾		Tj = 150° C	MAX	23	mΩ
	V - V	Tj = 25° C		5	μΑ
I _{DRM} I _{RRM}	$V_{DRM} = V_{RRM}$	Tj = 150° C	MAX	6.4	mA
'KKW	V _D /V _R = 400 V (at peak mains voltage)	Tj = 150° C		4.2	IIIA

^{1.} for both polarities of A2 referenced to A1

Table 4. Thermal resistance

Symbol	Parameter			Value	Unit
R _{th (j-c)}	Junction to case (AC)		D ² PAK TO-220AB		
			TO-220AB Ins	2.1	°C/W
		S _{CU} = 1 cm ²	D ² PAK	45	C/VV
R _{th (j-a)}	Junction to ambient		TO-220AB TO-220AB Ins	60	

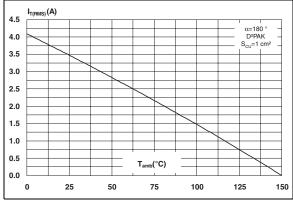
Figure 1. Maximum power dissipation Figure 2. RMS on-state current vs case vs RMS on-state current (full cycle) temperature (full cycle)



Characteristics T1635H Series

Figure 3. RMS on-state current vs ambient temperature, PCB FR4, e_{CU} = 35 μm

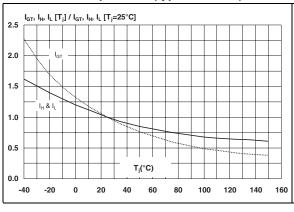
Figure 4. Relative variation of thermal impedance vs pulse duration



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Figure 5. Relative variation of gate trigger current, holding current and latching current vs junction temperature (typical values)

Figure 6. Surge peak on-state current vs number of cycles



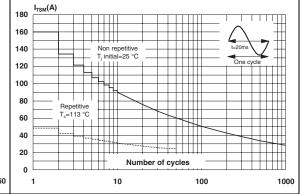
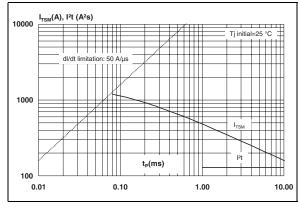
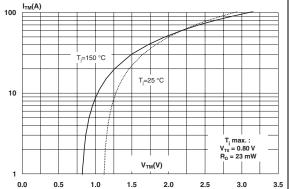


Figure 7. Non repetitive surge peak on-state current (sinusoidal pulse width tp<10 ms) and corresponding value of I²t

Figure 8. On-state characteristics (maximum values)





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Figure 9. Relative variation of critical rate of decrease of main current (di/dt)c versus junction temperature

Figure 10. Relative variation of critical rate of decrease of main current (di/dt)c vs reapplied dV/dt (typical values)

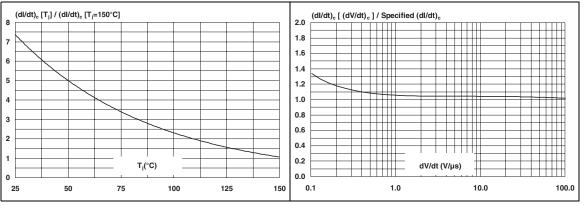


Figure 11. Variation of thermal resistance, junction to ambient versus copper surface under tab (PCB FR4, e_{CU} 35 μm)

Figure 12. Leakage current versus junction temperature for different values of blocking voltage (typical values)

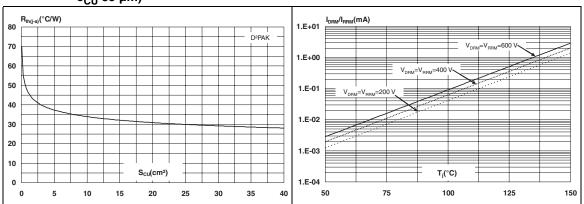
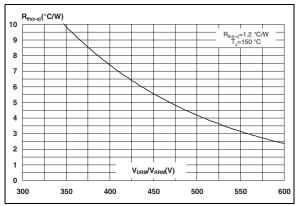
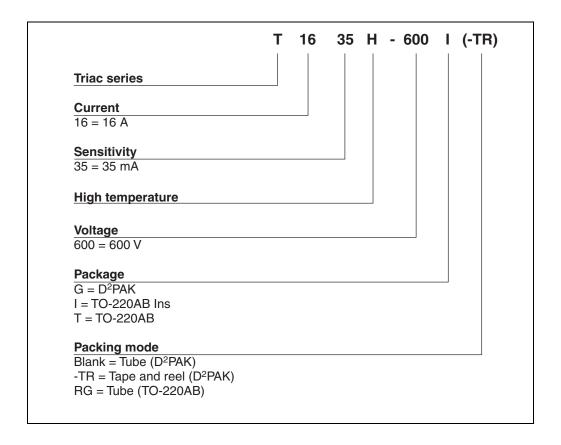


Figure 13. Acceptable repetitive peak off-state voltage versus caseambient thermal resistance



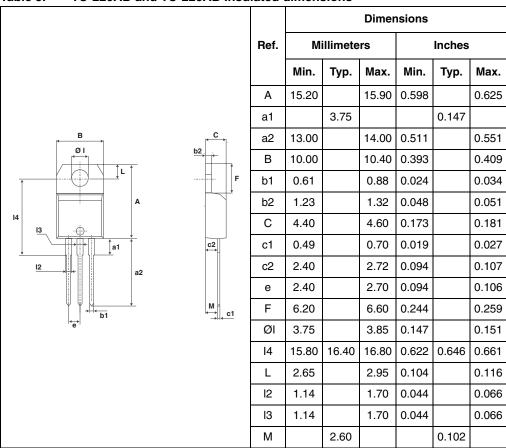
2 Ordering information scheme



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3 Package information

Table 5. TO-220AB and TO-220AB Insulated dimensions



Package information T1635H Series

Table 6. D²PAK Mechanical data

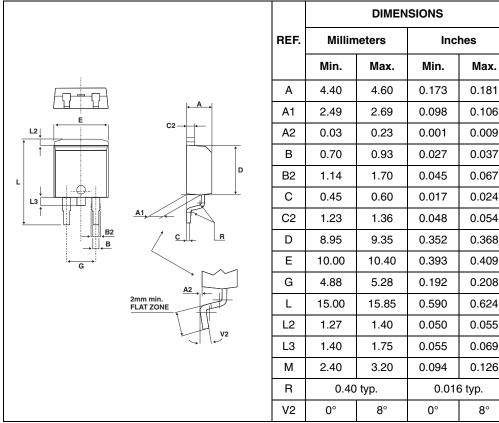
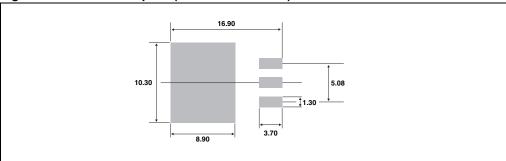


Figure 14. D²PAK Footprint (dimensions in mm)



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

4 Ordering information

Part number	Marking	Package	Weight	Base Qty	Packing mode
T1635H-600G	T1635H-600G	D ² PAK	1.5 g	50	Tube
T1635H-600G-TR	T1635H-600G	D ² PAK	1.5 g	1000	Tape and Reel
T1635H-600TRG	T1635H-600T	TO-220AB	2.3 g	50	Tube
T1635H-600IRG	T1635H-600I	TO-220AB Ins	2.3 g	50	Tube

5 Revision history

Date	Revision	Changes
31-Aug-2006	1	Initial release

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